

## TRANSISTOR (PNP)

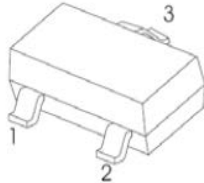
### SOT-23

#### Features

- As complementary type the PNP transistor MMBT3904 is recommended
- Epitaxial planar die construction

#### Marking: 2A

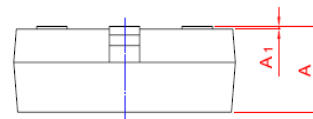
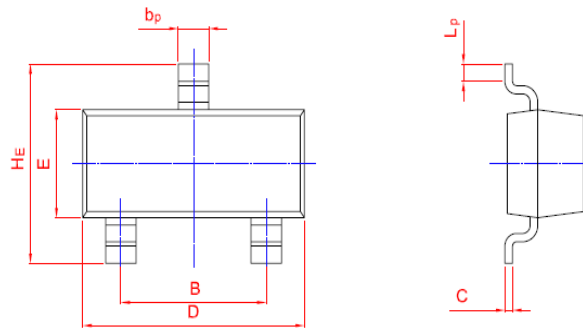
#### Pin figure



1. BASE

2. EMITTER

3. COLLECTOR



UNIT	A	B	bp	C	D	E	HE	A1	Lp
mm	1,40 0,95	2,04 1,78	0,50 0,35	0,19 0,08	3,10 2,70	1,65 1,20	3,00 2,20	0,100 0,013	0,50 0,20

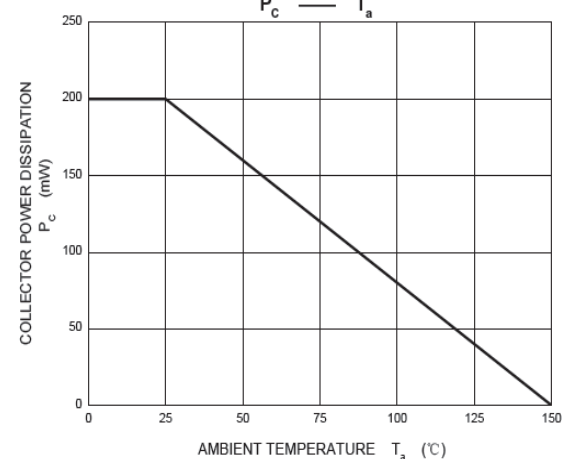
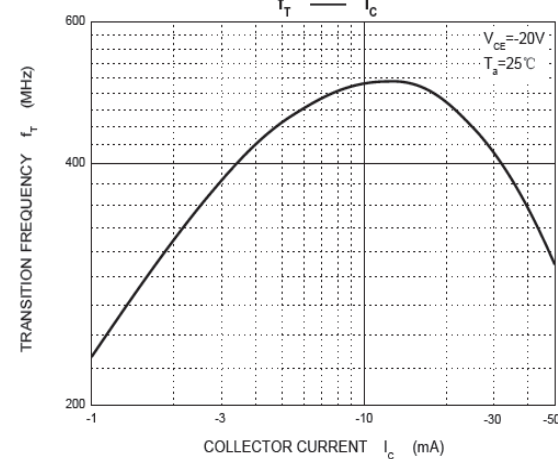
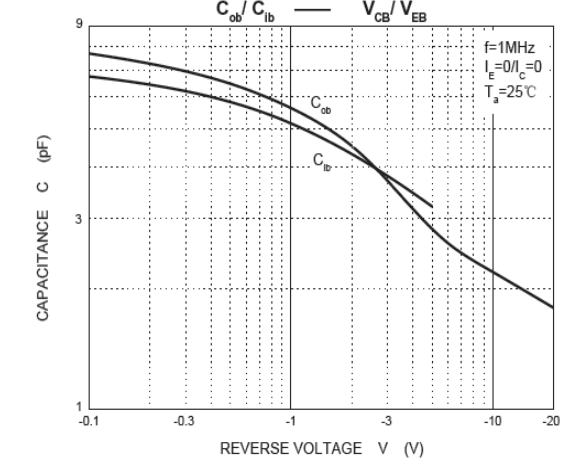
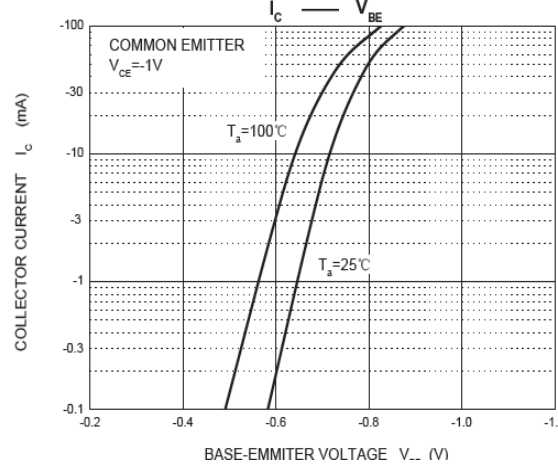
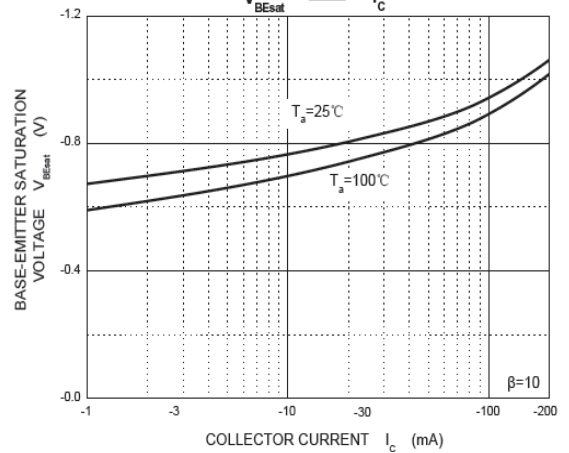
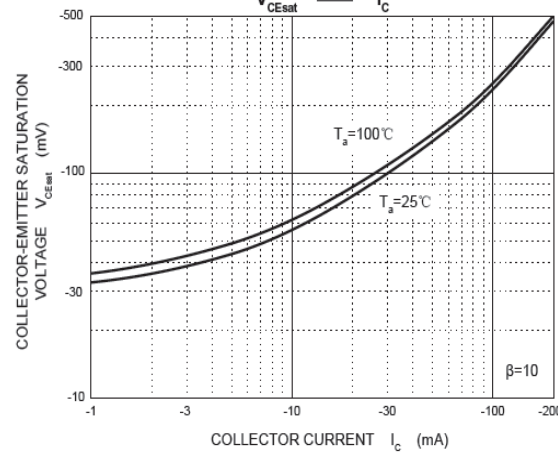
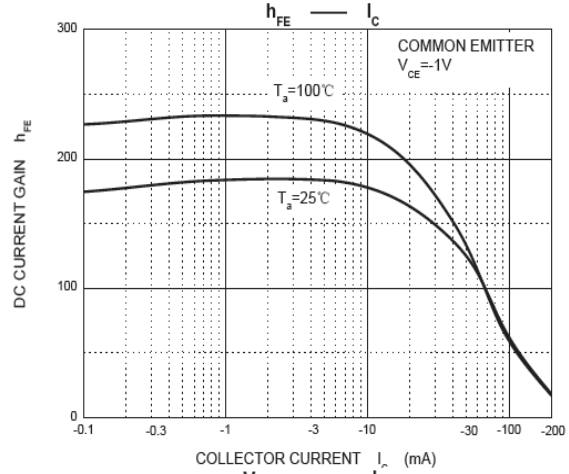
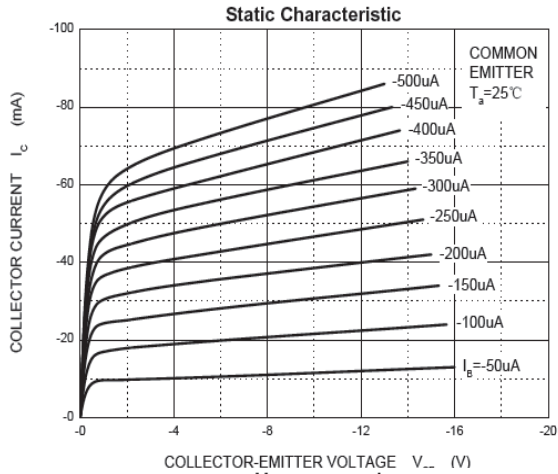
### MAXIMUM RATINGS (TA=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector-Base Voltage	VCBO	-40	V
Collector-Emitter Voltage	VCEO	-40	V
Emitter-Base Voltage	VEBO	-5	V
Collector Current-Continuous	IC	-200	mA
Total Device Dissipation	PC	200	mW
Thermal Resistance Junction to Ambient	RθJA	625	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	TSTG	-55 to +150	°C

### ELECTRICAL CHARACTERISTICS (Tamb=25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Max	Unit
Collector-Base Breakdown Voltage	VCBO	IC=-10μA, IE=0	-40	-	V
Collector-Emitter Breakdown Voltage	VCEO	IC=-1mA, IB=0	-40	-	V
Emitter-Base Breakdown Voltage	VEBO	IE=-10μA, IC=0	-5	-	V
Collector Cut-off Current	ICBO	VCE=-40V, IE=0	-	-0.1	μA
Collector Cut-off Current	ICEX	VCE=-30V, VBE(off)=-3V	-	-50	nA
Emitter Cut-off Current	IEBO	VEB=-5V, IC=0	-	-0.1	μA
DC Current Gain	hFE(1)	VCE=-1V, IC=-10mA	100	300	
	hFE(2)	VCE=-1V, IC=-50mA	60		
	hFE(3)	VCE=-1V, IC=-100mA	30		
Collector-Emitter Saturation Voltage	VCE(sat)	IC=-50mA, IB=-5mA		-0.3	V
Base-Emitter Saturation Voltage	VBE(sat)	IC=-50mA, IB=-5mA		-0.95	V
Transition Frequency	fT	VCE=-20V, IC=-10mA, f=100MHz	300		MHz
Delay Time	td	VCC=-3V, VBE=-0.5V		35	nS
Rise Time	tr	IC=-10mA, IB1=-IB2=-1mA		35	nS
Storage Time	ts	VCC=-3V, IC=-10mA,		225	nS
Fall Time	tf	IB1=-IB2=-1mA		75	nS

**RATING AND CHARACTERISTIC CURVES**  
**MMBT3906 (Halogen Free)**



MMBT3906-7H-99-00-BC1201

The curve graph is for reference only, can't be the basis for judgment(曲线图仅供参考)!

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